

PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package Pins	Package qty Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
MSP430F5630IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5630
MSP430F5630IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5630
MSP430F5631IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5631
MSP430F5631IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5631
MSP430F5632IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5632
MSP430F5632IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5632
MSP430F5632IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5632
MSP430F5632IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5632
MSP430F5632IZCAR	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5632
MSP430F5632IZCAR.Z	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5632
MSP430F5633IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5633
MSP430F5633IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5633
MSP430F5633IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5633
MSP430F5633IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5633
MSP430F5634IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5634
MSP430F5634IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5634
MSP430F5635IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5635
MSP430F5635IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5635
MSP430F5635IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5635
MSP430F5635IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5635

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MSP430F5635IZCAR	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5635
MSP430F5635IZCAR.Z	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5635
MSP430F5635IZCAT	Active	Production	NFBGA (ZCA) 113	250 SMALL T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5635
MSP430F5635IZCAT.Z	Active	Production	NFBGA (ZCA) 113	250 SMALL T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5635
MSP430F5636IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5636
MSP430F5636IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5636
MSP430F5636IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5636
MSP430F5636IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5636
MSP430F5636IZQWR	Obsolete	Production	BGA MICROSTAR JUNIOR (ZQW) 113	-	-	Call TI	Call TI	-	M430F5636
MSP430F5637IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5637
MSP430F5637IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5637
MSP430F5637IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5637
MSP430F5637IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5637
MSP430F5638IPZ	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5638
MSP430F5638IPZ.Z	Active	Production	LQFP (PZ) 100	90 JEDEC TRAY (10+1)	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5638
MSP430F5638IPZR	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5638
MSP430F5638IPZR.Z	Active	Production	LQFP (PZ) 100	1000 LARGE T&R	Yes	NIPDAU	Level-3-260C-168 HR	-40 to 85	M430F5638
MSP430F5638IZCAR	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5638
MSP430F5638IZCAR.Z	Active	Production	NFBGA (ZCA) 113	2500 LARGE T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5638
MSP430F5638IZCAT	Active	Production	NFBGA (ZCA) 113	250 SMALL T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5638
MSP430F5638IZCAT.Z	Active	Production	NFBGA (ZCA) 113	250 SMALL T&R	Yes	SNAGCU	Level-3-260C-168 HR	-40 to 85	F5638
MSP430F5638IZQWR	Obsolete	Production	BGA MICROSTAR JUNIOR (ZQW) 113	-	-	Call TI	Call TI	-40 to 85	M430F5638
MSP430F5638IZQWT	Obsolete	Production	BGA MICROSTAR JUNIOR (ZQW) 113	-	-	Call TI	Call TI	-40 to 85	M430F5638

(1) **Status:** For more details on status, see our [product life cycle](#).

(2) **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

(3) **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

(4) **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

(5) **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

(6) **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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